

DECLARATION FOR PATENT APPLICATION Docket No. NEKW 14.868

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled CHEMICALLY AMPLIFIED RESIST LARGE IN TRANSPARENCY AND SENSITIVITY TO EXPOSURE LIGHT LESS THAN 248 NANOMETER WAVELENGTH AND PROCESS OF

the specification of which

(check one) is attached hereto.

FORMING MASK

was filed on _____ as

Application Serial No. _____

and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

			Priority Claimed
		Yes	No
9-52678	Pat.	Japan	7, 3, 1997
10-38207	Pat.	Japan	20, 2, 1998
(Number)		(Country)	(Day/Month/Year Filed)
(Number)		(Country)	(Day/Month/Year Filed)
(Number)		(Country)	(Day/Month/Year Filed)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)

I hereby appoint as my attorney and agent Aaron B. Karas, Reg. No. 18,923, Samson Helfgott, Reg. No. 23,072 and Emma Shleifer, Reg. No. 29,734 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Address all correspondence to:

HELFGOTT & KARAS P.C.
60th Floor
Empire State Building
New York, New York 10118-0110
Telephone No. (212) 643-5000

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor

KAICHIRO NAKANO

Inventor's signature

Date 26, 2, 1998

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Citizenship Japan

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ADDITIONAL INVENTORS FOR DECLARATION/ASSIGNMENT

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Second Inventor's signature Katsumi Maeda Date 26, 2, 1998
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Third inventor's signature Shigeuki Iwasa Date 26, 2, 1998
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Full name of additional inventor _____
Fifth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Sixth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Seventh inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Eighth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Ninth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Tenth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Eleventh inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Twelfth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

Full name of additional inventor _____
Thirteenth inventor's signature _____ Date _____
Residence _____ Citizenship _____
Post Office Address _____

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Kaichiro NAKANO et al.

Filed : Concurrently herewith

For : CHEMICALLY AMPLIFIED RESIST LARGE IN TRANSPARENCY AND
SENSITIVITY TO EXPOSURE LIGHT LESS THAN 248 NANOMETER
WAVELENGTH AND PROCESS OF FORMING MASK

March 6, 1998

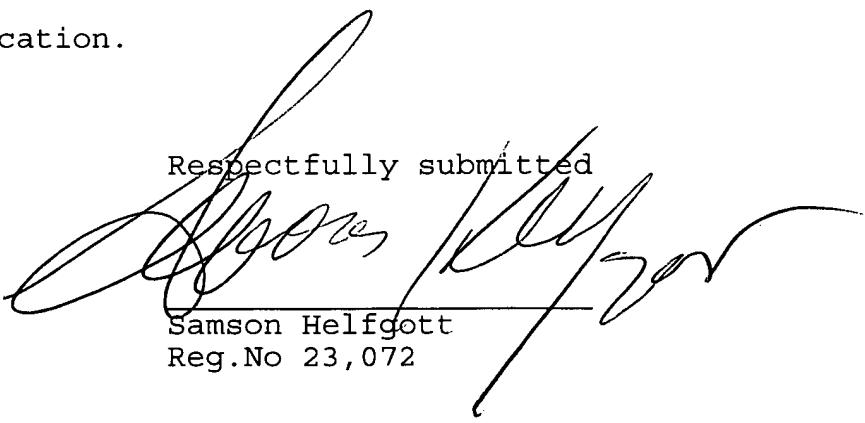
Hon. Commissioner of Patents
and Trademarks
Washington, D.C. 20231

SUB-POWER OF ATTORNEY

S I R:

I, Samson Helfgott Reg. No. 23,072 attorney of record herein, do hereby grant a sub-power of attorney to Leonard Cooper, Reg. No. 27,625, Russell Gross, Reg. No. 40,007 and James F. McLaughlin, Reg. No. 38,048 to act and sign in my behalf in the above-referenced application.

Respectfully submitted


Samson Helfgott
Reg. No 23,072

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LHH:power

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By J. Helfgott

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